

TS256MPA0256U

172PIN DDR2 400 Micro-DIMM
256MB With 32Mx16 CL3

Description

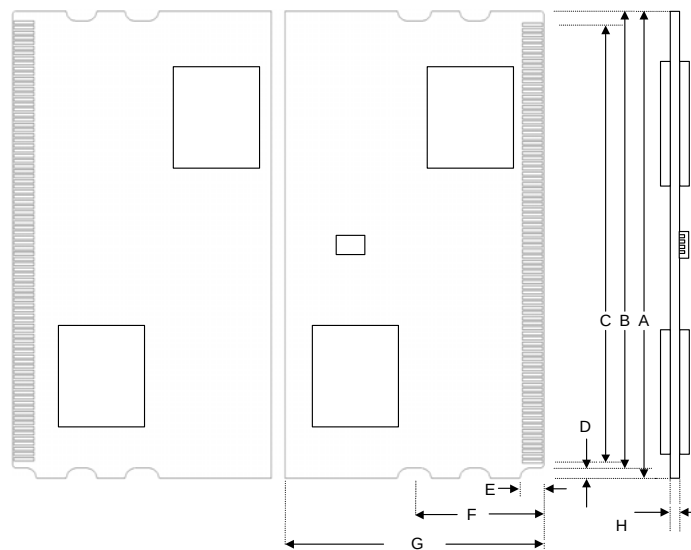
The TS256MPA0256U is a 32M x 64bits DDR2-400 Micro-DIMM. The TS256MPA0256U consists of 4pcs 32Mx16bits DDR2 SDRAMs in 84 ball FBGA packages and a 2048 bits serial EEPROM on a 172-pin printed circuit board. The TS256MPA0256U is available as non-ECC module in 1-row 32Mx64 organization and is intended for mounting into 172-pin edge connector sockets.

Synchronous design allows precise cycle control with the use of system clock. Data I/O transactions are possible on both edges of DQS. Range of operation frequencies, programmable latencies allow the same device to be useful for a variety of high bandwidth, high performance memory system applications.

Features

- RoHS compliant products.
- JEDEC standard 1.8V $\pm$ 0.1V Power supply
- VDDQ=1.8V $\pm$ 0.1V
- Max clock Freq: 200MHZ; 400Mb/s/Pin.
- Posted CAS
- Programmable CAS Latency: 3,4,5
- Programmable Additive Latency :0,1,2,3 and 4
- Write Latency (WL) = Read Latency (RL)-1
- Burst Length: 4,8(Interleave/nibble sequential)
- Programmable sequential / Interleave Burst Mode
- Bi-directional Differential Data-Strobe (Single-ended data-strobe is an optional feature)
- Off-Chip Driver (OCD) Impedance Adjustment
- MRS cycle with address key programs.
- On Die Termination
- Serial presence detect with EEPROM

Placement



PCB: 09-2420

Dimensions

Side	Millimeters	Inches
A	45.50 $\pm$ 0.20	1.791 $\pm$ 0.008
B	44.50	1.752
C	42.50	1.673
D	1.00	0.039
E	2.75 $\pm$ 0.10	0.108 $\pm$ 0.004
F	15.00	0.591
G	30.00 $\pm$ 0.20	0.984 $\pm$ 0.008
H	0.80 $\pm$ 0.10	0.031 $\pm$ 0.004

(Refer Placement)